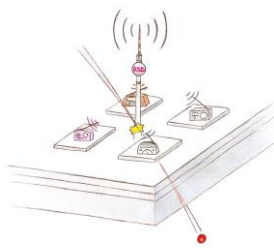


# An R&D path for the muColl silicon tracker



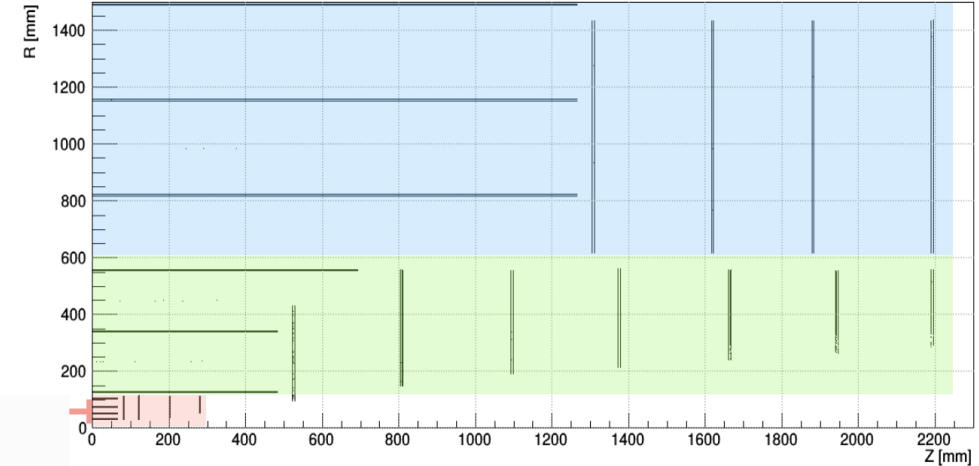
- Request for the muColl tracker
- State of the art of LGAD-based 4D sensors
- Path forward for a muColl tracker based on UFSD\_RSD

N. Bartosik, N. Cartiglia, N. Pastrone  
INFN, Torino

# Setting the stage: resolution and occupancy

## Silicon sensors with high spatial and timing resolution

- Outer Tracker  $\sigma_{\phi} \sim 7 \mu\text{m}, \sigma_z \sim 90 \mu\text{m}, \sigma_t \sim 60 \text{ ps}$  (strips)
- Inner Tracker  $\sigma_{\phi} \sim 7 \mu\text{m}, \sigma_z \sim 90 \mu\text{m}, \sigma_t \sim 60 \text{ ps}$  (macropixels)
- Vertex Detector  $\sigma_{\phi} \sim 5 \mu\text{m}, \sigma_z \sim 5 \mu\text{m}, \sigma_t \sim 30 \text{ ps}$  (pixel,  $25 \times 25 \mu\text{m}$ )
  - double layers with 2mm spacing
  - forward disks placed outside of the regions with highest BIB flux to minimize occupancy

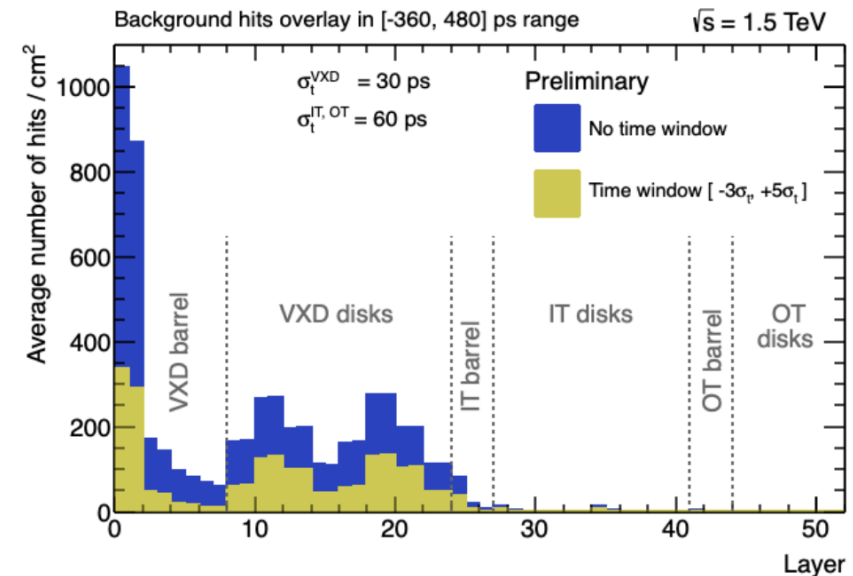


Fairly stringent requests for resolutions

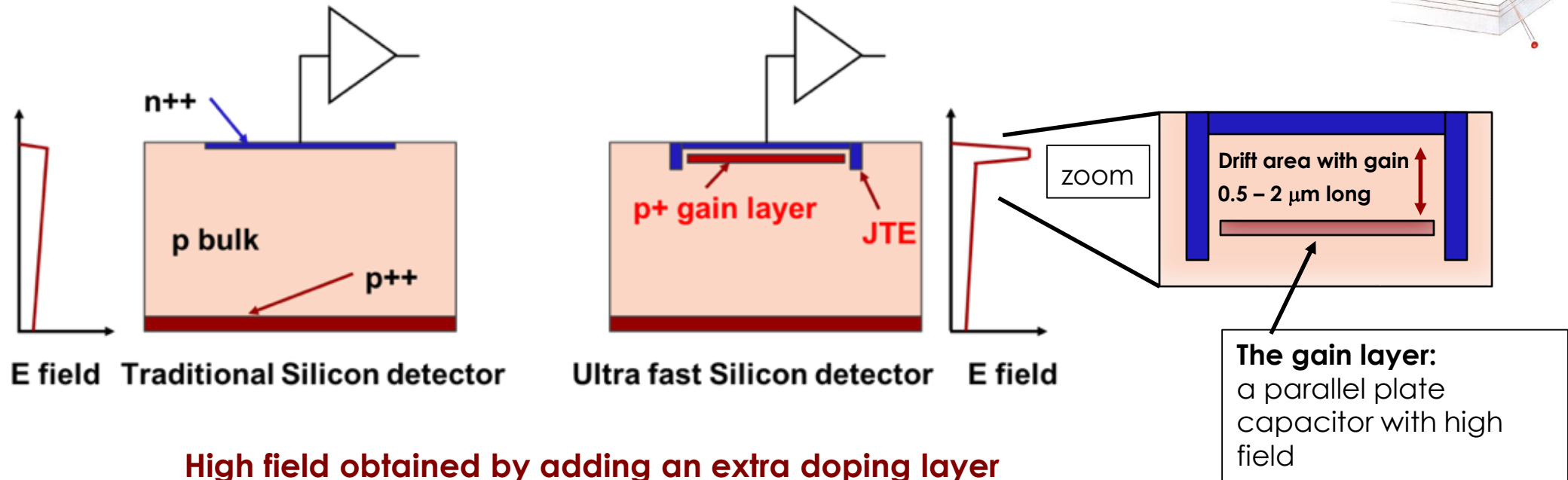
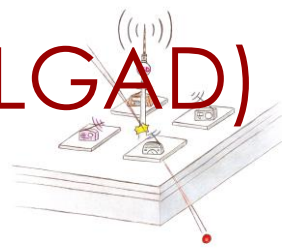
Very high occupancy in the vertex detector

To be combined with:

- As low as possible material budget
- As low as possible power consumption



# First design innovation: low gain avalanche diode (LGAD)



**High field obtained by adding an extra doping layer**

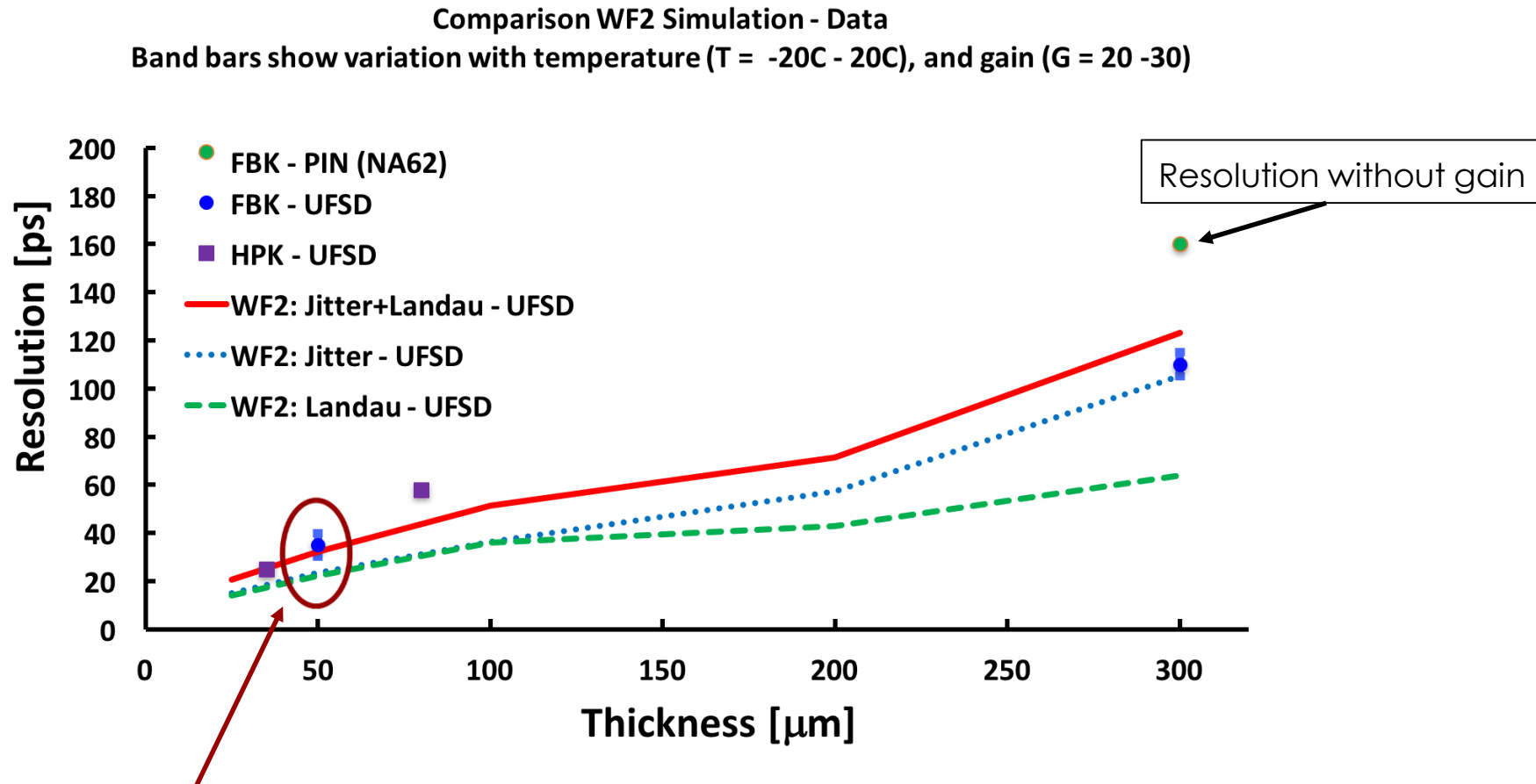
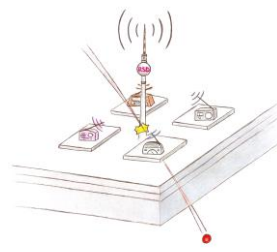
$E \sim 300 \text{ kV/cm}$ , closed to breakdown voltage

- The low-gain mechanism, obtained with a moderately doped p-implant, is the defining feature of the design.
- The low gain allows segmenting and keeping the shot noise below the electronic noise, since the leakage current is low.

**Low gain is the key ingredient to good temporal resolution**

LGAD optimized for timing are often called Ultra-Fast Silicon Detector (UFSD)

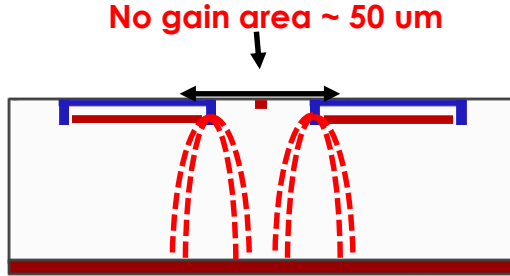
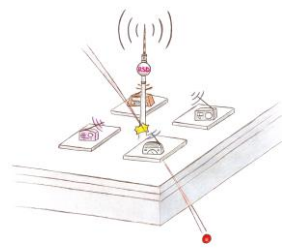
# Summary of UFSD temporal resolution



There are now hundreds of measurements on 45-55  $\mu\text{m}$ -thick UFSDs

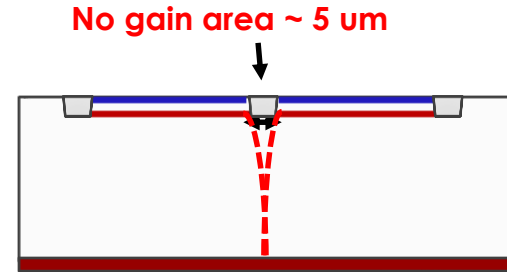
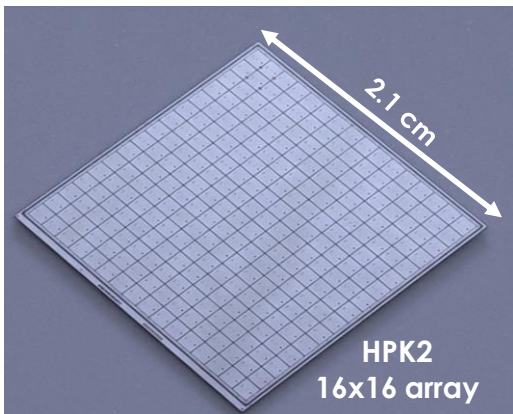
→ Current sensor choice for the ATLAS and CMS timing layers

# UFSD: State-of-the art



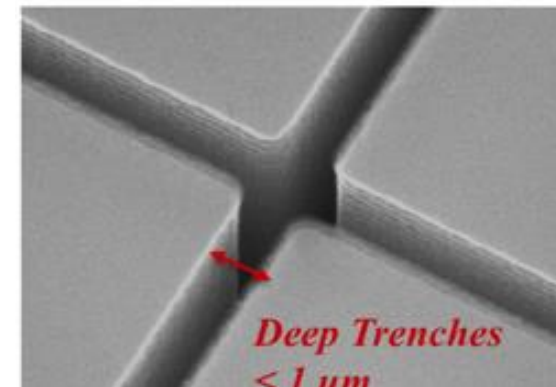
**JTE + p-stop design**

- CMS & ATLAS choice
- Not 100% fill factor
- Hit contained in a single pixel
- Very well tested
- High Occupancy OK
- Rate ~ 50-100 MHz
- Rad hardness ~ 2-3E15 n/cm<sup>2</sup>

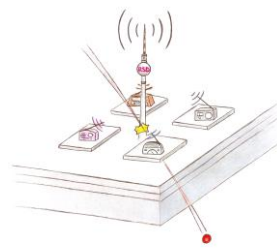


**Trench-isolated design**

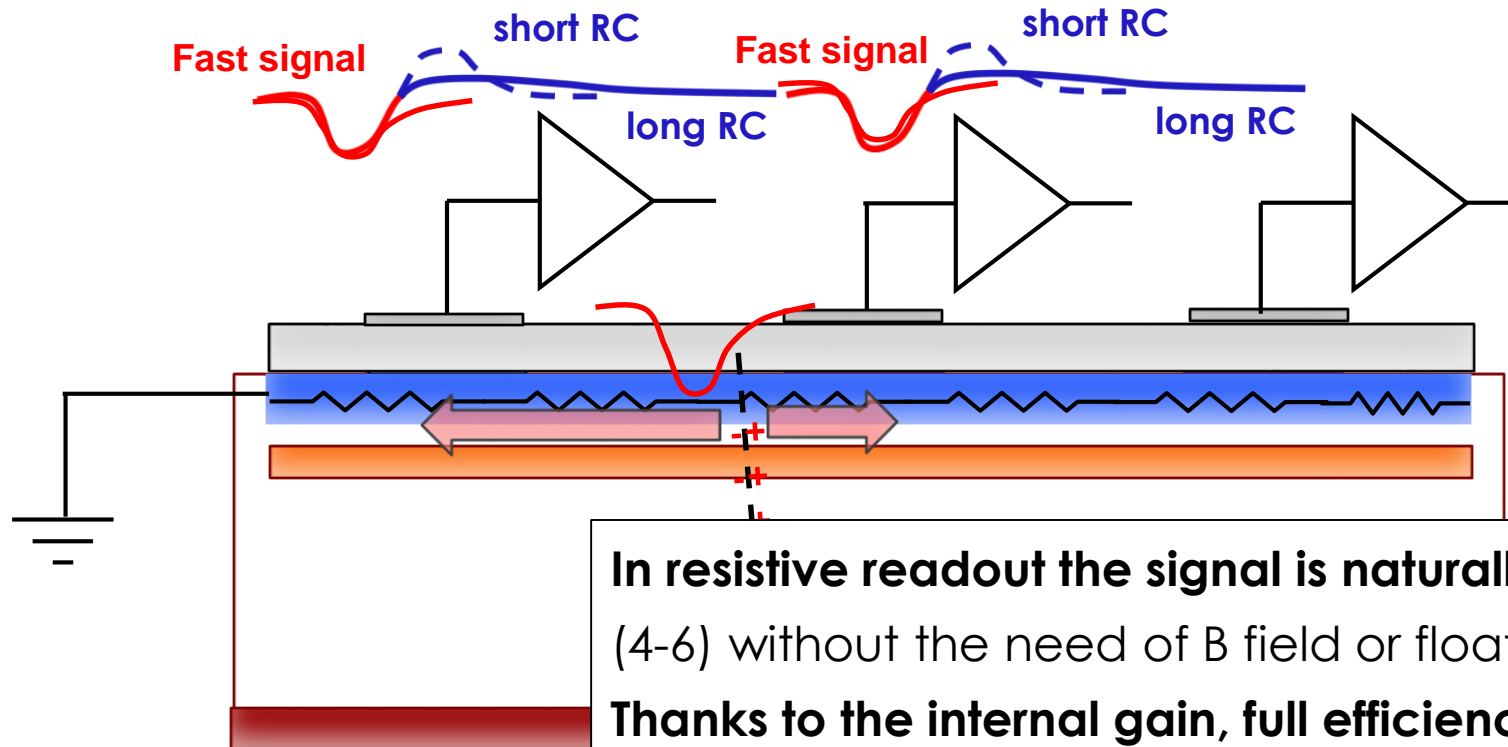
- Almost 100% fill factor
- Hit contained in a single pixel
- Temporal resolution (50  $\mu\text{m}$ ) : 35-40 ps
- High Occupancy OK
- Rate ~ 50-100 MHz
- Rad hardness: ~ 1E15 n/cm<sup>2</sup>



# Second design innovation: resistive read-out

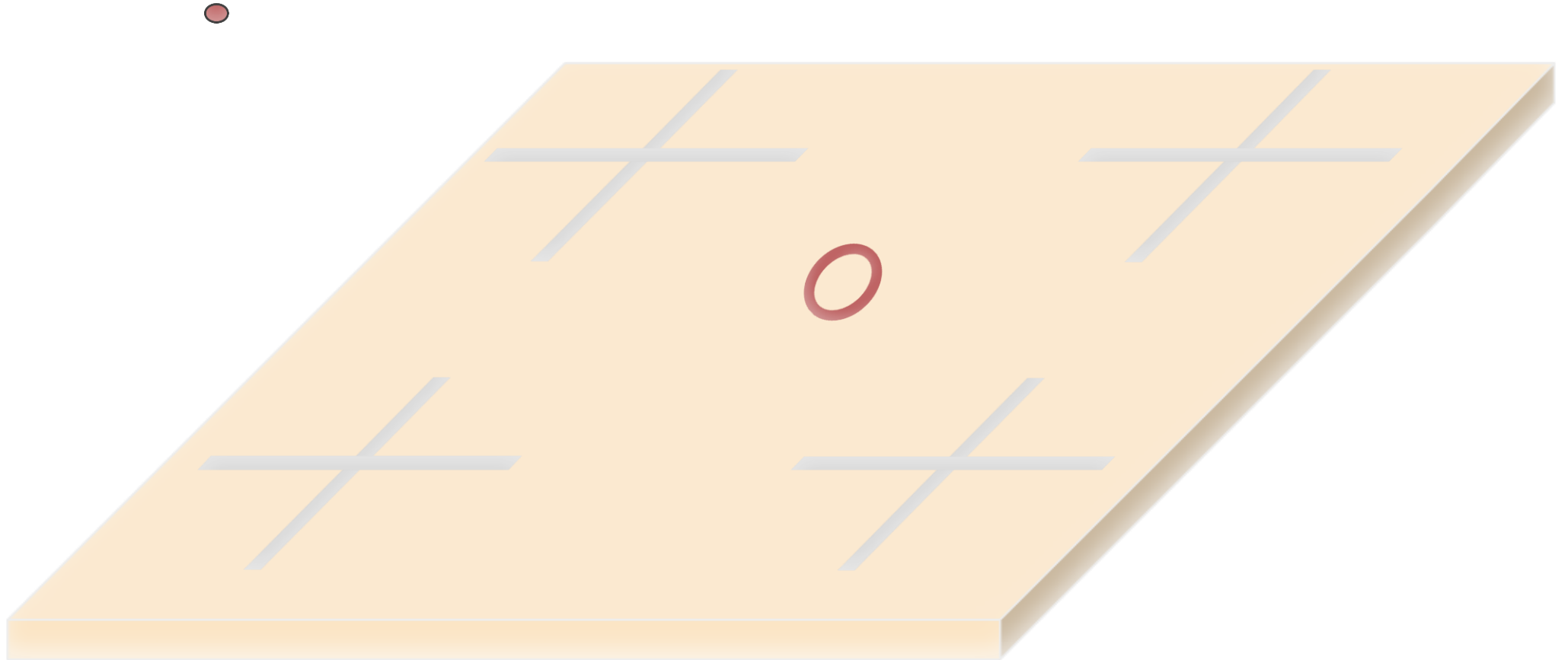
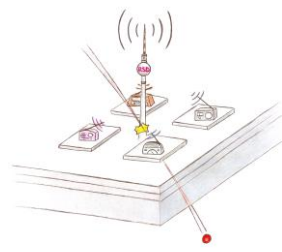


- The signal is formed on the n+ electrode ==> no signal on the AC pads
- The AC pads offer the smallest impedance to ground for the fast signal
- The signal discharges to ground

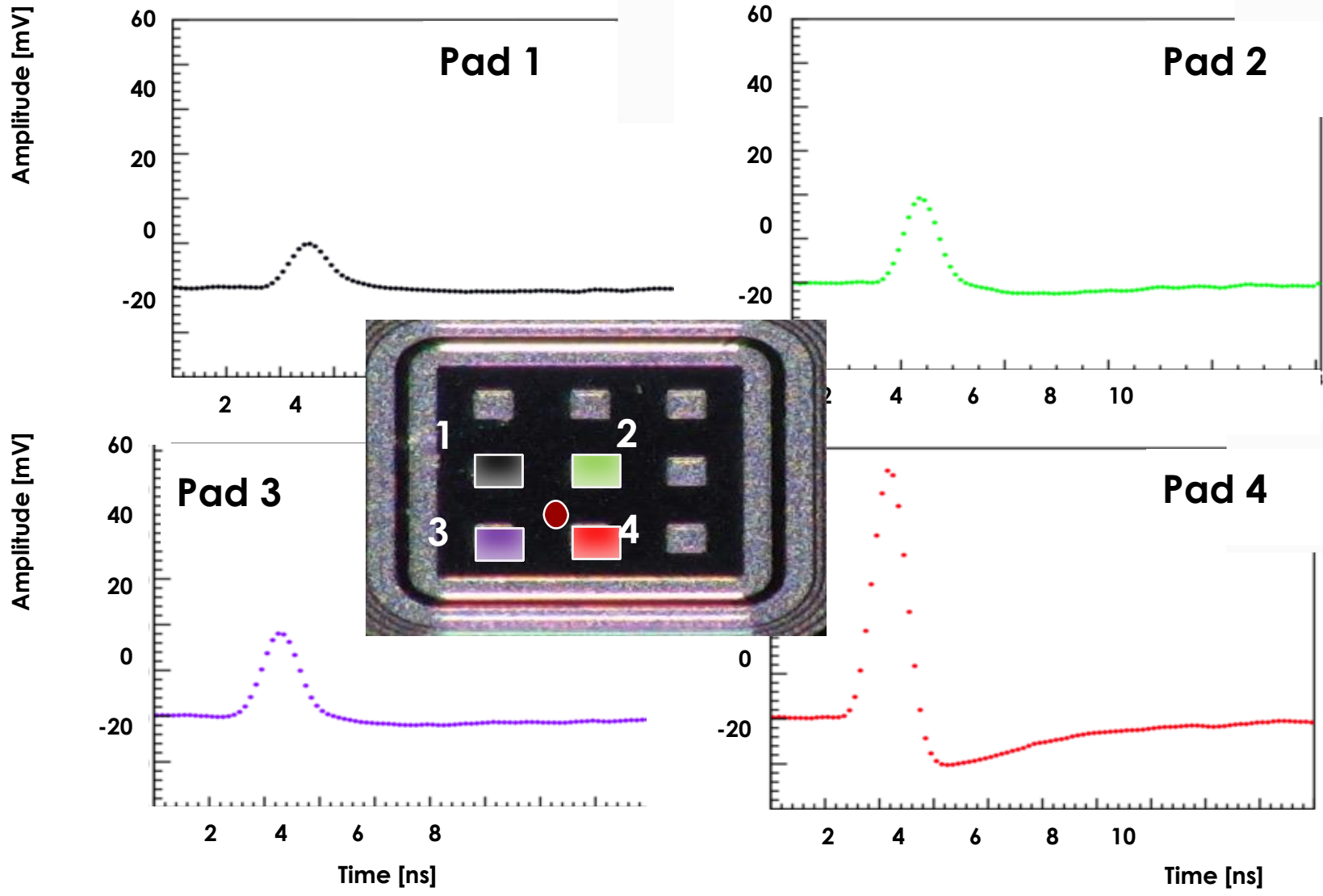
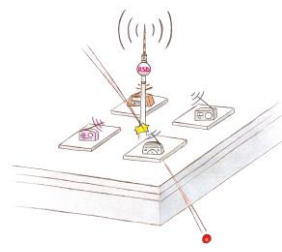


**In resistive readout the signal is naturally shared among pads (4-6) without the need of B field or floating pads**  
**Thanks to the internal gain, full efficiency even with sharing**  
**Results presented here are from the FBK RSD2 production**

# RSD principle of operation in motion



# Example of signal sharing



50-mm thick RSD,  
Gain ~ 20

The laser is shot at the position of the red dot: the signal is seen in 4 pads

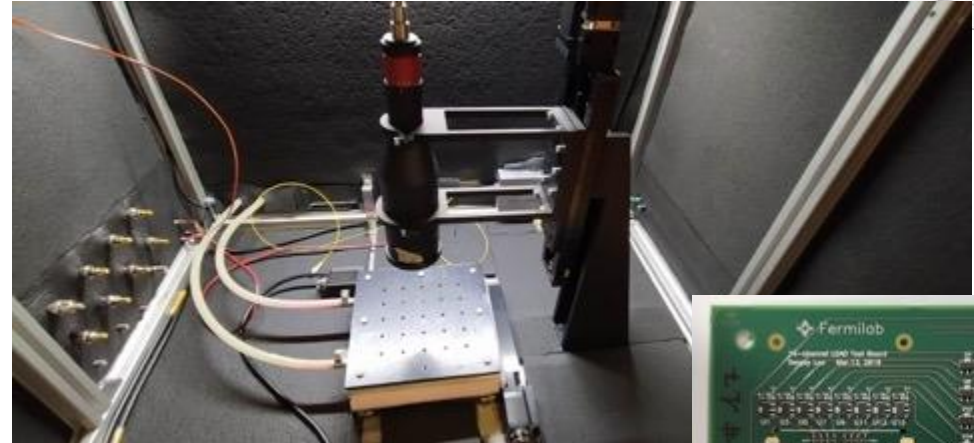


# Experimental set-up



The **Particulars TCT laser setup** has been used:

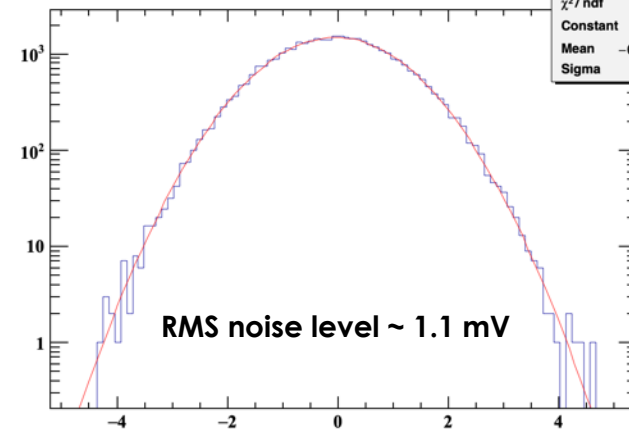
- IR laser generates a signal in the RSD,
- simulating the passage of a MIP
- laser spot size  $\sim 8 \mu\text{m}$
- Laser temporal precision:  $\sim 8 \text{ ps}$
- movable x-y stage provides reference positions of the laser shots, precision:  $\sigma_{\text{Laser}} \sim 2 \mu\text{m}$



**Sensors are read out with 16-ch fast analogue board, developed at FNAL**

**The signals are recorded with 16-ch CAEN Digitizer (5 Gs)**

Amplitude of pre-signal samples



Entries	38520
Mean	-0.05111
Std Dev	1.1
$\chi^2 / \text{ndf}$	77.03 / 80
Constant	1482 $\pm$ 9.2
Mean	-0.05023 $\pm$ 0.00560
Sigma	1.097 $\pm$ 0.004

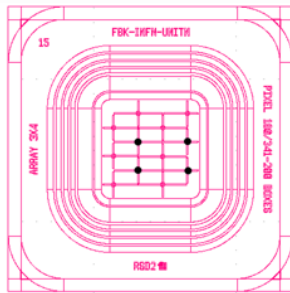
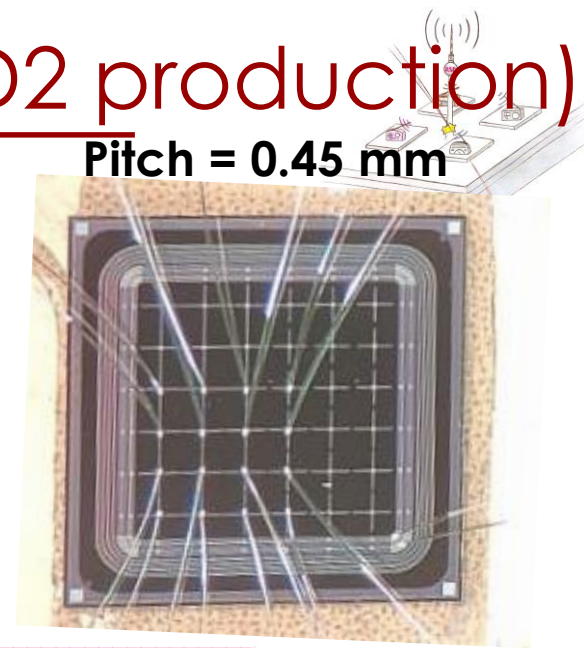
Amplitude [mV]

# RSD2 structures used in this analysis (FBK - RSD2 production)

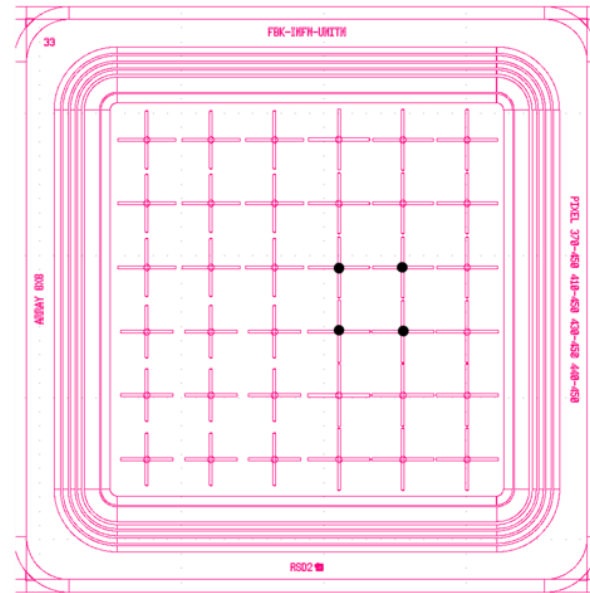
Pitch = 0.45 mm

In this study, the performance of sensors with electrodes shaped as crosses is presented.

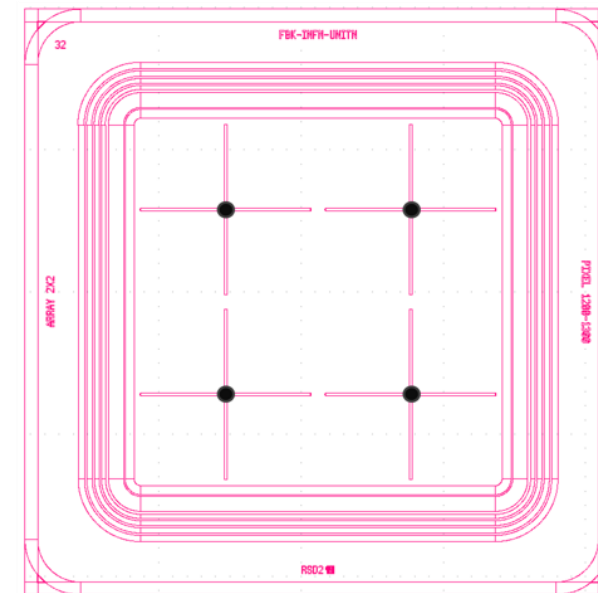
4 different dimensions: 200, 340, 450, and 1300  $\mu\text{m}$



(A)  
200 x 340  $\mu\text{m}^2$

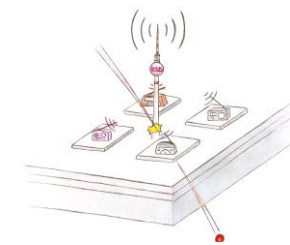


(B)  
Pitch = 450  $\mu\text{m}$



(C)  
Pitch = 1300  $\mu\text{m}$

# RSD position resolution (FBK RSD2 production)



RSDs at gain = 30 achieve a spatial resolution of about 2-3% of the pitch size:

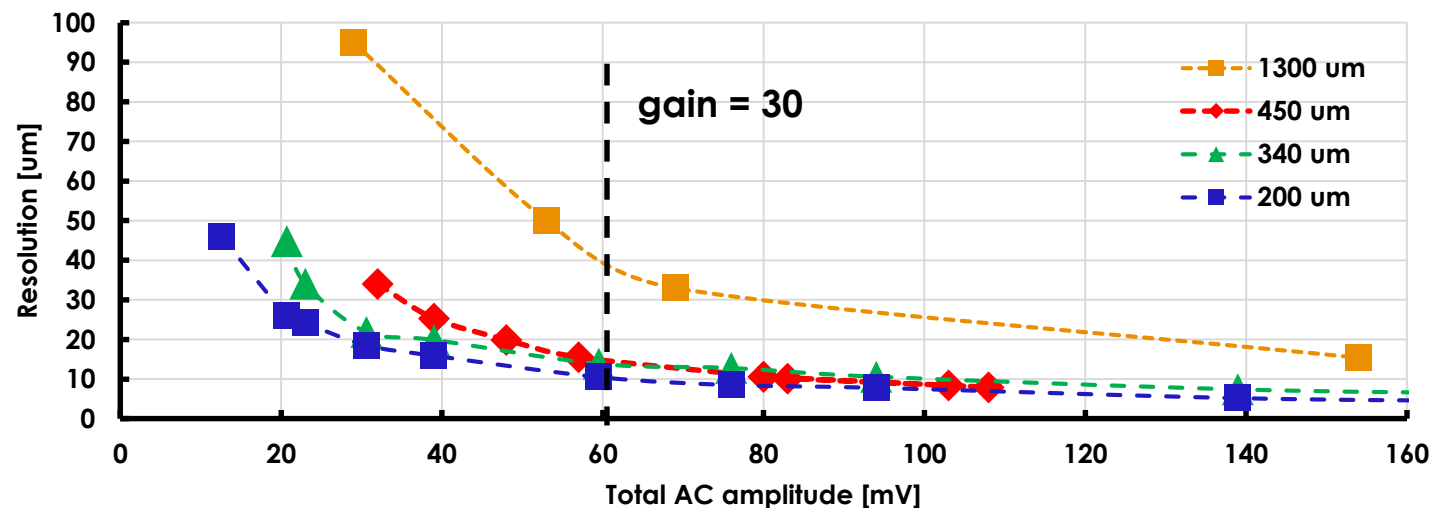
## RSD:

- 1300 x 1300 mm<sup>2</sup>:  $\sigma_x \sim 30 \mu\text{m}$
- 450 x 450 mm<sup>2</sup>:  $\sigma_x \sim 5 \mu\text{m}$

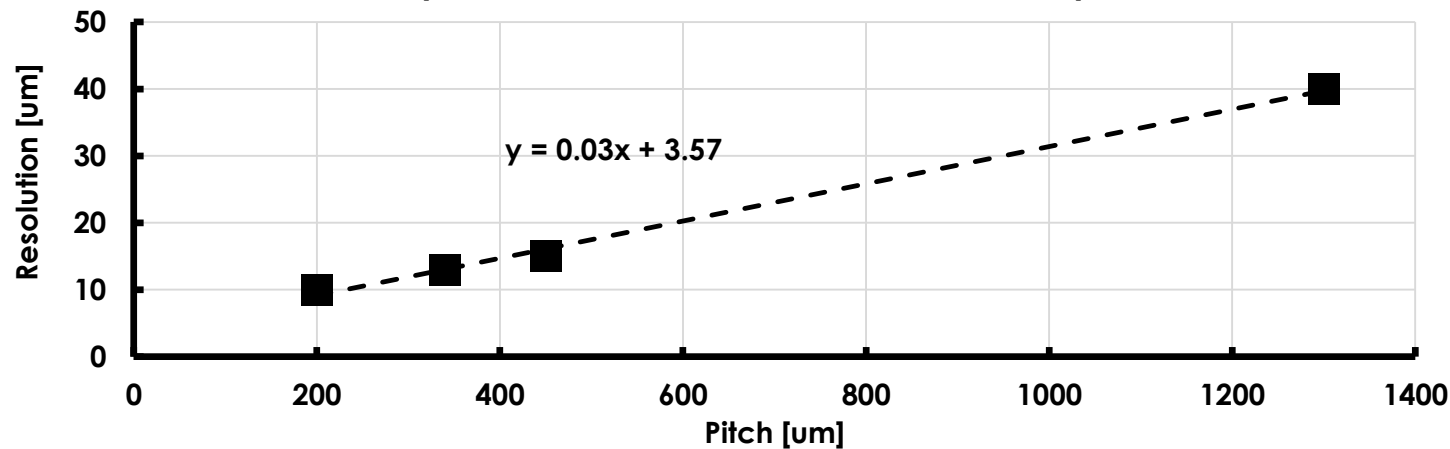
## Compared to a standard pixel

- 1300 x 1300 mm<sup>2</sup>:  $\sigma_x \sim 920 \mu\text{m}$
- 450 x 450 mm<sup>2</sup>:  $\sigma_x \sim 320 \mu\text{m}$

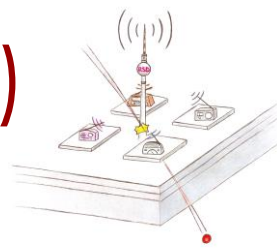
RSD2 crosses: spatial resolution for 4 different pitch sizes



RSD2 crosses: spatial resolution when the total AC amplitude = 60 mV

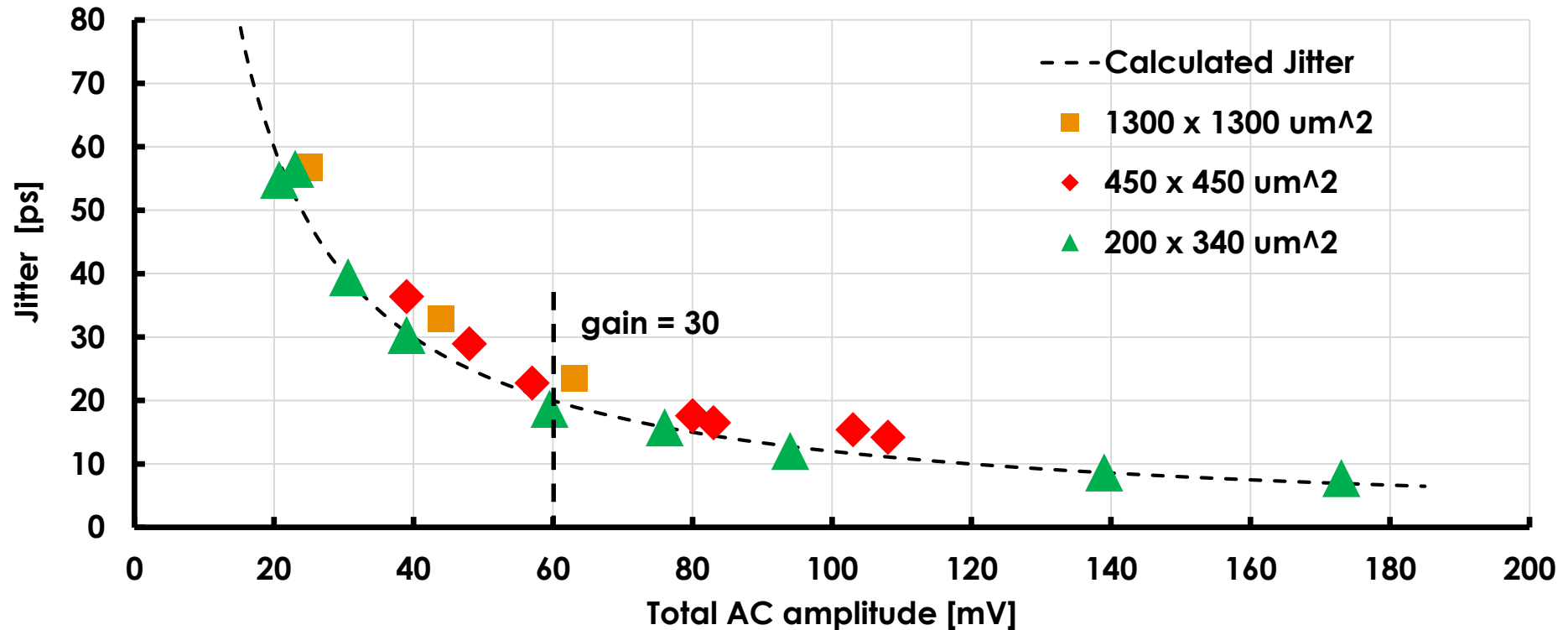


# RSD temporal resolution (FBK RSD2 production)

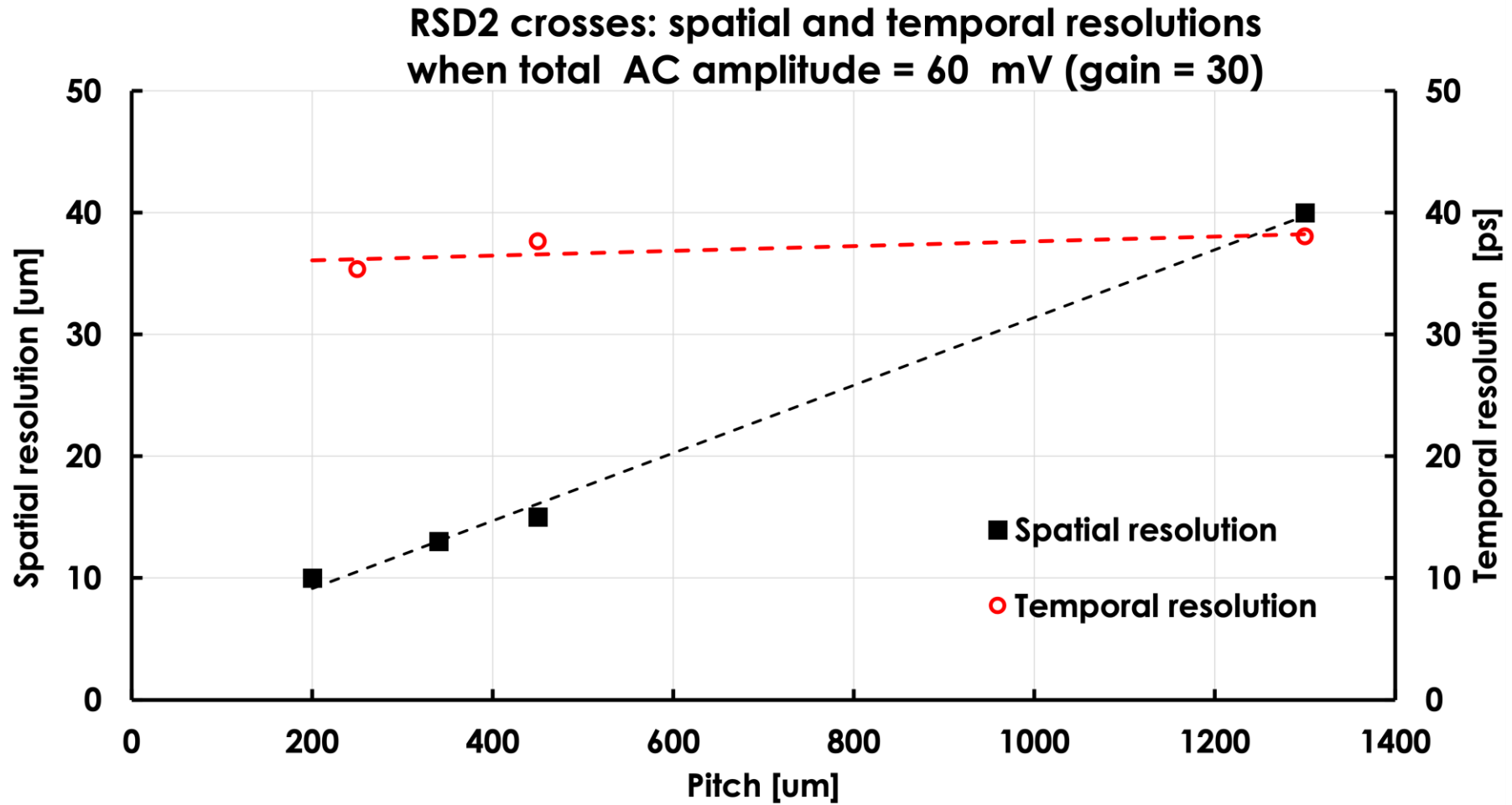
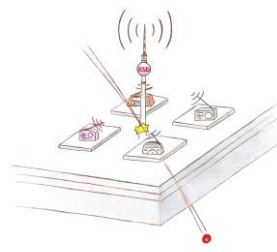


The **resolution** depends mostly upon the signal size and **weakly on the pixel size**  
RSDs at gain = 30 achieve a temporal jitter of about 20 ps

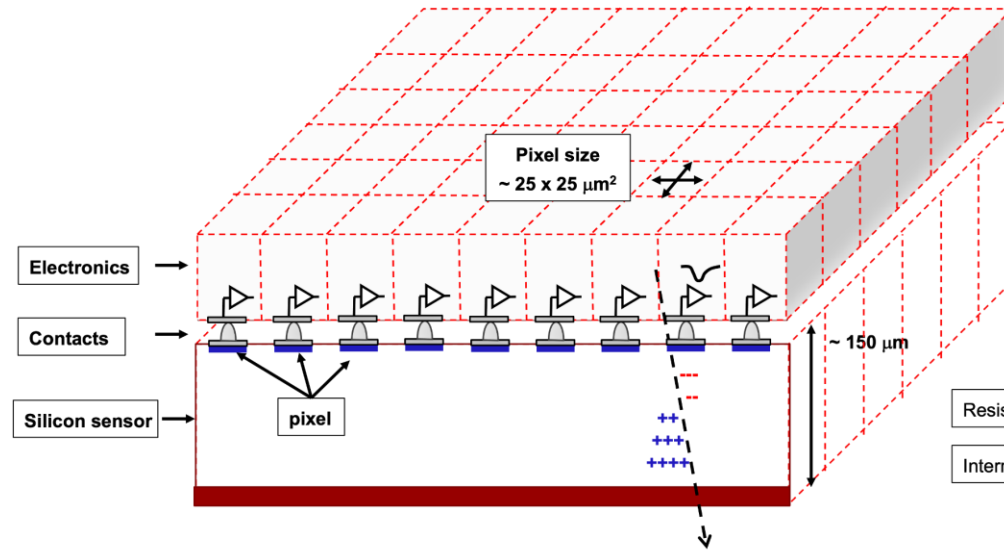
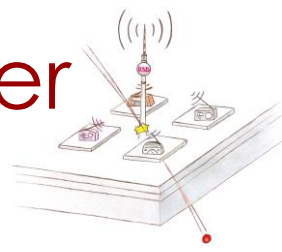
RSD2 Crosses: time jitter for 3 different pixel sizes



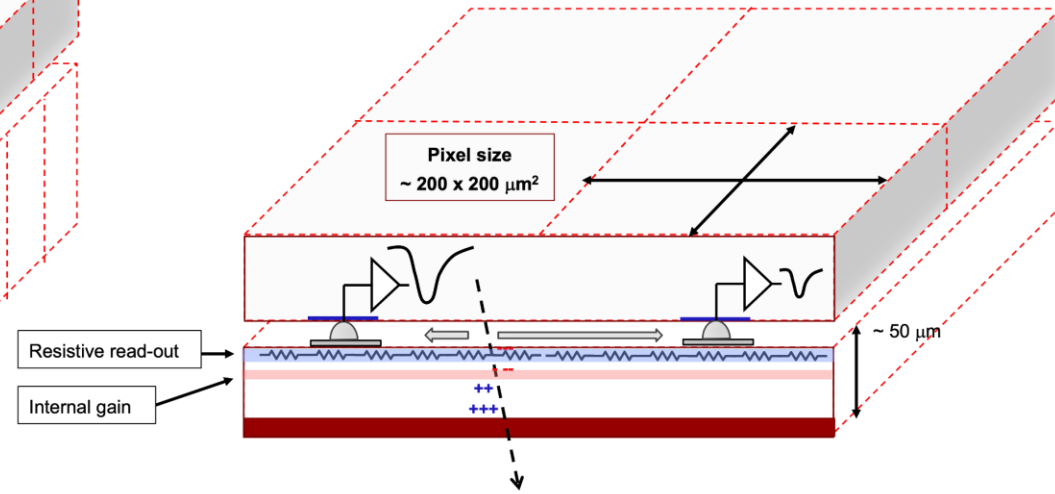
# RSD2 performance summary



# Final goal of RSD R&D: a completely new tracker



**Standard tracker**



**RSD-based tracker**

## The design of a tracker based on RSD is truly innovative:

- It delivers  $\sim 20$  - $30$  ps temporal resolution
- For the same spatial resolution, the number of pixel is reduced by 50-100
- The electronic circuitry can be easily accomodated
- The power consumption is much lower, it might even be air cooled ( $\sim 0.1$ - $0.2$  W/cm<sup>2</sup>)
- The sensors can be really thin

# Matching UFSD-RSD capabilities to the muColl requests



		cell size	sensor thickness	time resolution	spatial resolution	number of cells
VXD	B	25 $\mu\text{m}$ $\times$ 25 $\mu\text{m}$ pixels	50 $\mu\text{m}$	30 ps	5 $\mu\text{m}$ $\times$ 5 $\mu\text{m}$	729M
	E	25 $\mu\text{m}$ $\times$ 25 $\mu\text{m}$ pixels	50 $\mu\text{m}$	30 ps	5 $\mu\text{m}$ $\times$ 5 $\mu\text{m}$	462M

High occupancy and levels.  
**TI-LGAD** can be used up to 1-2E15 n/cm<sup>2</sup>  
 R&D in radiation harness needed to cover the full radiation field

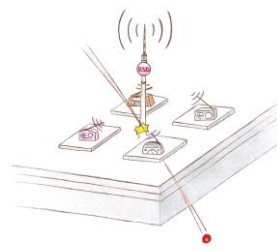
IT	B	50 $\mu\text{m}$ $\times$ 1 mm macropixels	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	164M
	E	50 $\mu\text{m}$ $\times$ 1 mm macropixels	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	127M

Low occupancy and radiation levels. Ideal for macro-pixels.  
 Pixel size, spatial, and temporal resolutions are a perfect fit for present RSD technology  
**RSD** will strongly reduce the number of pixels

OT	B	50 $\mu\text{m}$ $\times$ 10 mm microstrips	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	117M
	E	50 $\mu\text{m}$ $\times$ 10 mm microstrips	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	56M

Very Low-occupancy and radiation levels. Long strips do not provide accurate temporal resolution.  
 Propose to replace it with **RSD macro pads**

# Conclusions



UFSD and RSD offer very good combined spatial and temporal performances  
 These designs are a good fit to the need of the muColl design

## Proposed detector

		cell size	sensor thickness	time resolution	spatial resolution	number of cells	Cell size	Number of cells	Thickness	Detector
VXD	B	25 $\mu\text{m}$ $\times$ 25 $\mu\text{m}$ pixels	50 $\mu\text{m}$	30 ps	5 $\mu\text{m}$ $\times$ 5 $\mu\text{m}$	729M	To be decided		50 $\mu\text{m}$	TI_LGAD
	E	25 $\mu\text{m}$ $\times$ 25 $\mu\text{m}$ pixels	50 $\mu\text{m}$	30 ps	5 $\mu\text{m}$ $\times$ 5 $\mu\text{m}$	462M				
IT	B	50 $\mu\text{m}$ $\times$ 1 mm macropixels	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	164M	200 $\mu\text{m}$ x 2 mm	1/8 # of present design	50 $\mu\text{m}$	RSD
	E	50 $\mu\text{m}$ $\times$ 1 mm macropixels	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	127M				
OT	B	50 $\mu\text{m}$ $\times$ 10 mm microstrips	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	117M	200 $\mu\text{m}$ x 2 mm	Similar to the present design	50 $\mu\text{m}$	RSD
	E	50 $\mu\text{m}$ $\times$ 10 mm microstrips	100 $\mu\text{m}$	60 ps	7 $\mu\text{m}$ $\times$ 90 $\mu\text{m}$	56M				

Very difficult (impossible?) to achieve good timing with strips  
 Better to use macro-pads?

In Torino we are continuing the development of TI-LGAD and RSD for applications to the muColl tracker